

## 1A High-Speed MOSFET Drivers

### Features

- Latch-Up Protected: Withstands 500 mA Reverse Current
- Input Withstands Negative Inputs Up to 5V
- Electrostatic Discharge (ESD) Protected: 2.0 kV (HBM) and 400V (MM)
- High Peak Output Current: 1A
- Wide Input Supply Voltage Operating Range:
  - 4.5V to 16V
- High Capacitive Load Drive Capability:
  - 1000 pF in 25 ns
- Short Delay Time: 30 ns typical
- Matched Delay Times
- Low Supply Current
  - With Logic '1' Input: 500  $\mu$ A
  - With Logic '0' Input: 100  $\mu$ A
- Low Output Impedance: 8 $\Omega$
- Available in Space-Saving 8-pin MSOP Package
- Pinout – same as TC1410/TC1412/TC1413

### Applications

- Switch Mode Power Supplies
- Pulse Transformer Drive
- Line Drivers
- Relay Driver

### General Description

The TC1411/TC1411N are 1A CMOS buffers/drivers. They do not latch up under any conditions within their power and voltage ratings. They are not subject to damage when up to 5V of noise spiking of either polarity occurs on the ground pin. They can accept, without damage or logic upset, up to 500 mA of current of either polarity being forced back into their output. All terminals are fully protected against Electrostatic Discharge (ESD) up to 2.0 kV (HBM) and 400V (MM).

As MOSFET drivers, the TC1411/TC1411N can easily charge a 1000 pF gate capacitance in 25 ns with matched rise and fall times. To ensure that the MOSFET's intended state is not affected even by large transients, low enough impedance in both the 'ON' and 'OFF' states are provided. The leading and trailing edge propagation delay times are also matched to allow driving short-duration inputs with greater accuracy.

### Package Types



# TC1411/TC1411N

## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Voltage .....	+20V
Input Voltage .....	$V_{DD} + 0.3V$ to GND – 5.0V
Power Dissipation ( $T_A \leq 70^\circ C$ )	
MSOP .....	340 mW
PDIP .....	730 mW
SOIC.....	470 mW
Storage Temperature Range .....	-65°C to +150°C
Maximum Junction Temperature .....	+150°C

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### DC CHARACTERISTICS

**Electrical Specifications:** Unless otherwise noted, over the operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ . Typical values are measured at  $T_A = +25^\circ C$ ,  $V_{DD} = 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Input</b>						
Logic '1', High Input Voltage	$V_{IH}$	2.0	—	—	V	
Logic '0', Low Input Voltage	$V_{IL}$	—	—	0.8	V	
Input Current	$I_{IN}$	-1.0	—	1.0	$\mu A$	$0V \leq V_{IN} \leq V_{DD}$ , $T_A = +25^\circ C$
		-10	—	10		$-40^\circ C \leq T_A \leq +85^\circ C$
<b>Output</b>						
High Output Voltage	$V_{OH}$	$V_{DD} - 0.025$	—	—	V	DC Test
Low Output Voltage	$V_{OL}$	—	—	0.025	V	DC Test
Output Resistance	$R_O$	—	8	11	$\Omega$	$V_{DD} = 16V$ , $I_O = 10 mA$ , $T_A = +25^\circ C$
		—	10	14		$0^\circ C \leq T_A \leq +70^\circ C$
		—	10	14		$-40^\circ C \leq T_A \leq +85^\circ C$
Peak Output Current	$I_{PK}$	—	1.0	—	A	$V_{DD} = 16V$
Latch-Up Protection Withstand Reverse Current	$I_{REV}$	—	0.5	—	A	Duty cycle $\leq 2\%$ , $t \leq 300 \mu s$ , $V_{DD} = 16V$
<b>Switching Time (Note 1)</b>						
Rise Time	$t_R$	—	25	35	ns	$T_A = +25^\circ C$
		—	27	40		$0^\circ C \leq T_A \leq +70^\circ C$
		—	29	40		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Fall Time	$t_F$	—	25	35	ns	$T_A = +25^\circ C$
		—	27	40		$0^\circ C \leq T_A \leq +70^\circ C$
		—	29	40		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Delay Time	$t_{D1}$	—	30	40	ns	$T_A = +25^\circ C$
		—	33	45		$0^\circ C \leq T_A \leq +70^\circ C$
		—	35	45		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Delay Time	$t_{D2}$	—	30	40	ns	$T_A = +25^\circ C$
		—	33	45		$0^\circ C \leq T_A \leq +70^\circ C$
		—	35	45		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>

**Note 1:** Switching times ensured by design.

# TC1411/TC1411N

## DC CHARACTERISTICS (CONTINUED)

**Electrical Specifications:** Unless otherwise noted, over the operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ . Typical values are measured at  $T_A = +25^\circ C$ ,  $V_{DD} = 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Power Supply</b>						
Power Supply Current	$I_S$	—	0.5	1.0	mA	$V_{IN} = 3V, V_{DD} = 16V$
		—	0.1	0.15		$V_{IN} = 0V$

**Note 1:** Switching times ensured by design.

## TEMPERATURE CHARACTERISTICS

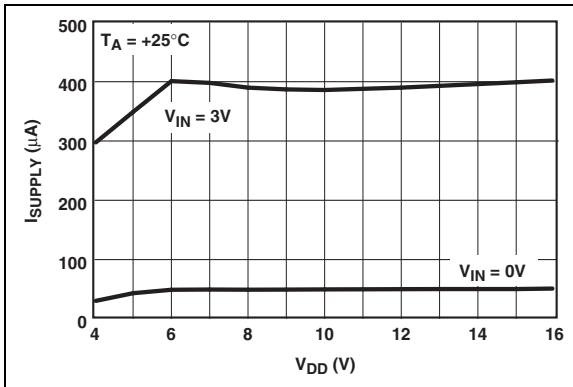
**Electrical Specifications:** Unless otherwise noted, all parameters apply with  $4.5V \leq V_{DD} \leq 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Temperature Ranges</b>						
Specified Temperature Range (C)	$T_A$	0	—	+70	$^\circ C$	
Specified Temperature Range (E)	$T_A$	-40	—	+85	$^\circ C$	
Specified Temperature Range (V)	$T_A$	-40	—	+125	$^\circ C$	
Maximum Junction Temperature	$T_J$	—	—	+150	$^\circ C$	
Storage Temperature Range	$T_A$	-65	—	+150	$^\circ C$	
<b>Package Thermal Resistances</b>						
Thermal Resistance, 8L-MSOP	$\theta_{JA}$	—	211	—	$^\circ C/W$	
Thermal Resistance, 8L-PDIP	$\theta_{JA}$	—	89.3	—	$^\circ C/W$	
Thermal Resistance, 8L-SOIC	$\theta_{JA}$	—	149.5	—	$^\circ C/W$	

## 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

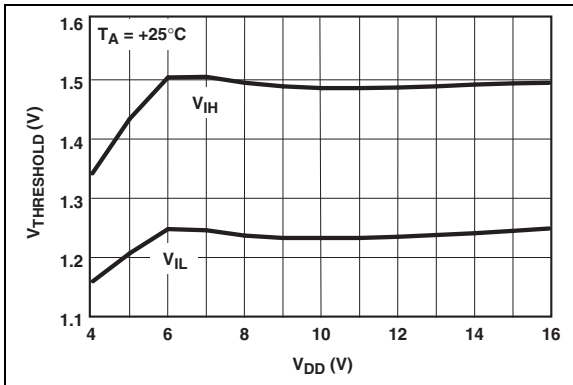
**Note:** Unless otherwise indicated, over operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ .



**FIGURE 2-1:** Quiescent Supply Current vs. Supply Voltage.



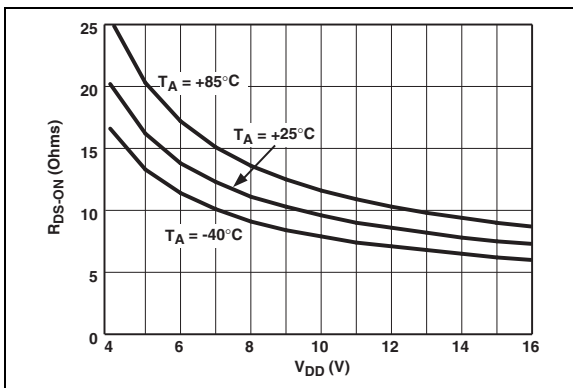
**FIGURE 2-4:** Quiescent Supply Current vs. Temperature.



**FIGURE 2-2:** Input Threshold vs. Supply Voltage.



**FIGURE 2-5:** Input Threshold vs. Temperature.



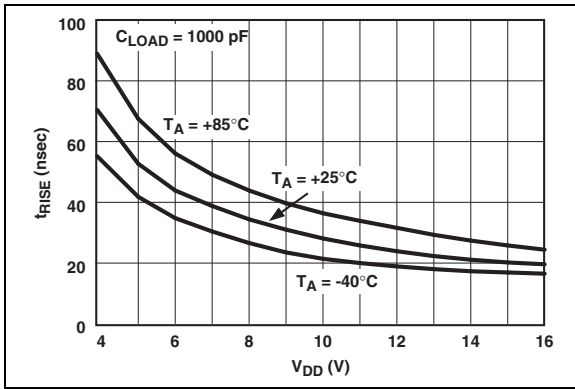
**FIGURE 2-3:** High-State Output Resistance vs. Supply Voltage.



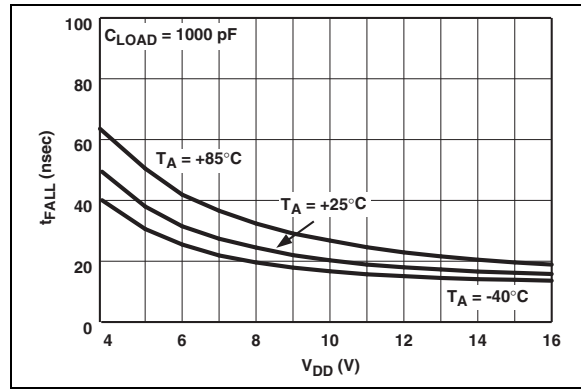
**FIGURE 2-6:** Low-State Output Resistance vs. Supply Voltage.

# TC1411/TC1411N

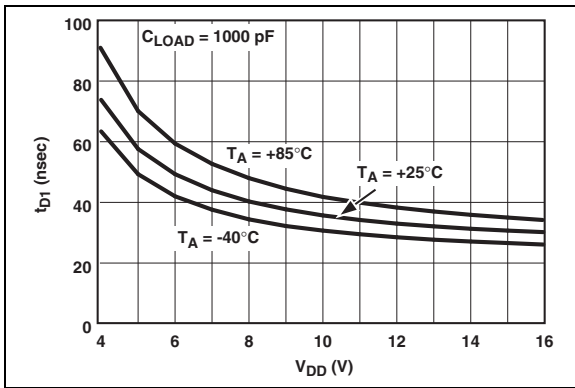
**Note:** Unless otherwise indicated, over operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ .



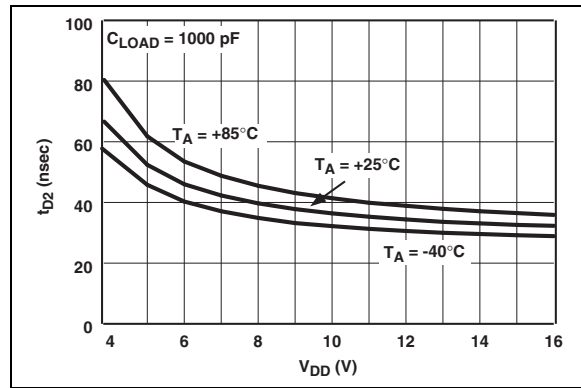
**FIGURE 2-7:** Rise Time vs. Supply Voltage.



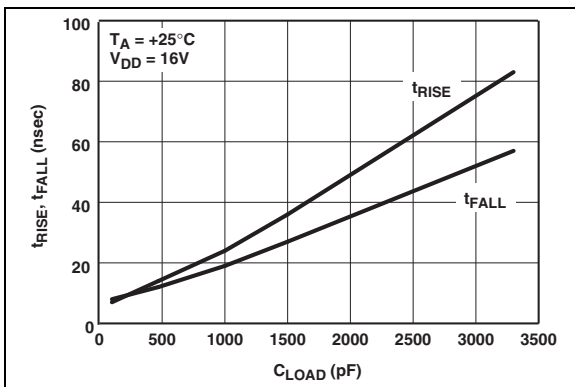
**FIGURE 2-10:** Fall Time vs. Supply Voltage.



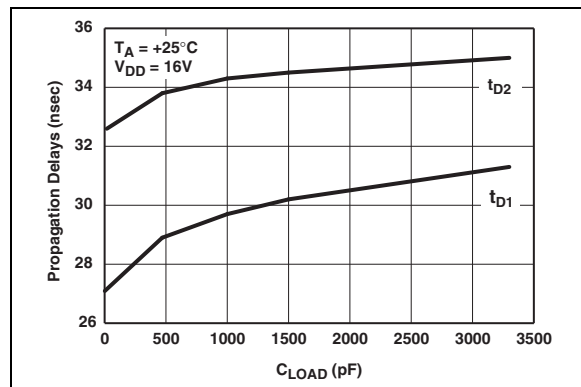
**FIGURE 2-8:** Propagation Delay vs. Supply Voltage.



**FIGURE 2-11:** Propagation Delay vs. Supply Voltage.



**FIGURE 2-9:** Rise and Fall Times vs. Capacitive Load.



**FIGURE 2-12:** Propagation Delays vs. Capacitive Load.

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

Pin No.	TC1411 MSOP, PDIP, SOIC	TC1411N MSOP, PDIP, SOIC	Description
1	$V_{DD}$	$V_{DD}$	Supply input, 4.5V to 16V
2	IN	IN	Control input
3	NC	NC	No connection
4	GND	GND	Ground
5	GND	GND	Ground
6	$\overline{\text{OUT}}$	OUT	CMOS push-pull output, common to pin 7
7	$\overline{\text{OUT}}$	OUT	CMOS push-pull output, common to pin 6
8	$V_{DD}$	$V_{DD}$	Supply input, 4.5V to 16V

### 3.1 Supply Input ( $V_{DD}$ )

The  $V_{DD}$  input is the bias supply for the MOSFET driver and is rated for 4.5V to 16V with respect to the ground pin. The  $V_{DD}$  input should be bypassed to ground with a local ceramic capacitor. The value of the capacitor is chosen based on the capacitive load that is being driven. A value of 1.0  $\mu\text{F}$  is suggested.

### 3.2 Control Input (IN)

The MOSFET driver input is a high-impedance, TTL/CMOS-compatible input. The input has 300 mV of hysteresis between the high and low thresholds that prevents output glitching even when the rise and fall time of the input signal is very slow.

### 3.3 CMOS Push-pull Output (OUT, $\overline{\text{OUT}}$ )

The MOSFET driver output is a low impedance, CMOS push-pull style output, capable of driving a capacitive load with 1A peak currents.

### 3.4 Ground (GND)

The ground pins are the return path for the bias current and for the high peak currents which discharge the load capacitor. The ground pins should be tied into a ground plane or have very short traces to the bias supply source return.

### 3.5 No Connect (NC)

No internal connection.

# TC1411/TC1411N

## 4.0 APPLICATION INFORMATION



**FIGURE 4-1:** Switching Time Test Circuit.

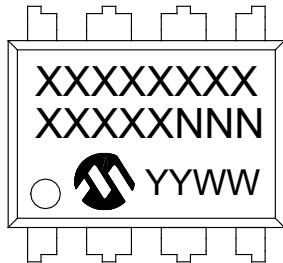


## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

8-Lead PDIP (300 mil)

Example



OR



<b>Legend:</b>	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	RoHS Compliant JEDEC designator for Matte Tin (Sn)
	*	This package is RoHS Compliant. The RoHS Compliant JEDEC designator ((e3)) can be found on the outer packaging for this package.

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

# TC1411/TC1411N

---

8-Lead SOIC (3.90 mm)



Example



OR



8-Lead MSOP (3x3 mm)



Example



## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-111C Sheet 1 of 2

# TC1411/TC1411N

## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N		8	
Pitch	e	0.65 BSC		
Overall Height	A	-	-	1.10
Molded Package Thickness	A2	0.75	0.85	0.95
Standoff	A1	0.00	-	0.15
Overall Width	E	4.90 BSC		
Molded Package Width	E1	3.00 BSC		
Overall Length	D	3.00 BSC		
Foot Length	L	0.40	0.60	0.80
Footprint	L1	0.95 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.08	-	0.23
Lead Width	b	0.22	-	0.40

**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M.  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111C Sheet 2 of 2

## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C	4.40		
Overall Width	Z			5.85
Contact Pad Width (X8)	X1			0.45
Contact Pad Length (X8)	Y1			1.45
Distance Between Pads	G1	2.95		
Distance Between Pads	GX	0.20		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2111A

# TC1411/TC1411N

## 8-Lead Plastic Dual In-Line (PA) – 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



Dimension Limits	Units	INCHES		
		MIN	NOM	MAX
Number of Pins	N	8		
Pitch	e	.100 BSC		
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.348	.365	.400
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

**Notes:**

- Pin 1 visual index feature may vary, but must be located with the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-018B

## 8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing No. C04-057C Sheet 1 of 2

# TC1411/TC1411N

## 8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Pins	N		8		
Pitch	e		1.27 BSC		
Overall Height	A	-	-	-	1.75
Molded Package Thickness	A2		1.25	-	-
Standoff §	A1		0.10	-	0.25
Overall Width	E		6.00 BSC		
Molded Package Width	E1		3.90 BSC		
Overall Length	D		4.90 BSC		
Chamfer (Optional)	h		0.25	-	0.50
Foot Length	L		0.40	-	1.27
Footprint	L1		1.04 REF		
Foot Angle	$\varphi$		0°	-	8°
Lead Thickness	c		0.17	-	0.25
Lead Width	b		0.31	-	0.51
Mold Draft Angle Top	$\alpha$		5°	-	15°
Mold Draft Angle Bottom	$\beta$		5°	-	15°

### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2



## 8-Lead Plastic Small Outline (OA) – Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C	5.40		
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

# TC1411/TC1411N

---

NOTES:

## APPENDIX A: REVISION HISTORY

### Revision E (June 2013)

The following is the list of modifications:

- Updated the values for Electrostatic Discharge (ESD) in the [Features](#) and [General Description](#) columns.
- Updated the Pin Description table in [Section 3.0, Pin Descriptions](#).
- Updated package marking information and drawings in [Section 5.0, Packaging Information](#).
- Minor grammatical and spelling corrections.

### Revision D (September 2006)

- Added -40°C to +125°C temperature range to Temperature Characteristics table and Product Information System page.
- Added disclaimer to package outline drawings.

### Revision C (March 2003)

- Added 8-Lead MSOP Package.

### Revision B (May 2002)

- Converted TELCOM data sheet for Embedded Control Handbook

### Revision A (March 2001)

- Original Release of this Document.

# TC1411/TC1411N

---

NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>	
Device	Temperature Range	Package	
<p><b>Device:</b> TC1411: 1 A Single MOSFET Driver, Inverting            TC1411N: 1 A Single MOSFET Driver, Non-Inverting</p> <p><b>Temperature Range:</b> C = 0°C to +70°C            E = -40°C to +85°C            V = -40°C to +125°C</p> <p><b>Package:</b> OA = Plastic SOIC, (150 mil Body), 8-lead            OA713 = Plastic SOIC, (150 mil Body), 8-lead (Tape and Reel)            UA = Plastic Micro Small Outline (MSOP), 8-lead *            UA713 = Plastic Micro Small Outline (MSOP), 8-lead * (Tape and Reel)            PA = Plastic DIP (300 mil Body), 8-lead            * MSOP package is only available in E-Temp.</p>			
			<p><b>Examples:</b></p> <p>a) TC1411COA: 1A Single MOSFET driver, 8LD SOIC package, 0°C to +70°C.</p> <p>b) TC1411CPA: 1A Single MOSFET driver, 8LD PDIP package, 0°C to +70°C.</p> <p>c) TC1411EUA713: Tape and Reel, 1A Single MOSFET driver, 8LD MSOP package, -40°C to +85°C.</p> <p>d) TC1411VOA713: Tape and Reel, 1A Single MOSFET driver, 8LD SOIC package, -40°C to +125°C.</p> <p>a) TC1411NCPA: 1A Single MOSFET driver, 8LD PDIP package, 0°C to +70°C.</p> <p>b) TC1411NEPA: 1A Single MOSFET driver, 8LD PDIP package, -40°C to +85°C.</p> <p>c) TC1411NEUA: 1A Single MOSFET driver, 8LD MSOP package, -40°C to +85°C.</p> <p>d) TC1411NVPA: 1A Single MOSFET driver, 8LD PDIP package, -40°C to +125°C.</p>

# TC1411/TC1411N

---

NOTES:

## THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at [www.microchip.com](http://www.microchip.com). This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at [www.microchip.com](http://www.microchip.com). Under "Support", click on "Customer Change Notification" and follow the registration instructions.

## CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

**Technical support is available through the web site at: <http://microchip.com/support>**

# TC1411/TC1411N

---

NOTES:



---

**Note the following details of the code protection feature on Microchip devices:**

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as “unbreakable.”

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

---

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

#### **Trademarks**

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC<sup>32</sup> logo, rPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniclient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2001-2013, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.

ISBN: 978-1-62077-244-7

**QUALITY MANAGEMENT SYSTEM**  
**CERTIFIED BY DNV**  
**== ISO/TS 16949 ==**

*Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC<sup>®</sup> MCUs and dsPIC<sup>®</sup> DSCs, KEELOQ<sup>®</sup> code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.*



# MICROCHIP

## Worldwide Sales and Service

### AMERICAS

**Corporate Office**  
2355 West Chandler Blvd.  
Chandler, AZ 85224-6199  
Tel: 480-792-7200  
Fax: 480-792-7277  
Technical Support:  
<http://www.microchip.com/support>  
Web Address:  
[www.microchip.com](http://www.microchip.com)

**Atlanta**  
Duluth, GA  
Tel: 678-957-9614  
Fax: 678-957-1455

**Boston**  
Westborough, MA  
Tel: 774-760-0087  
Fax: 774-760-0088

**Chicago**  
Itasca, IL  
Tel: 630-285-0071  
Fax: 630-285-0075

**Cleveland**  
Independence, OH  
Tel: 216-447-0464  
Fax: 216-447-0643

**Dallas**  
Addison, TX  
Tel: 972-818-7423  
Fax: 972-818-2924

**Detroit**  
Farmington Hills, MI  
Tel: 248-538-2250  
Fax: 248-538-2260

**Indianapolis**  
Noblesville, IN  
Tel: 317-773-8323  
Fax: 317-773-5453

**Los Angeles**  
Mission Viejo, CA  
Tel: 949-462-9523  
Fax: 949-462-9608

**Santa Clara**  
Santa Clara, CA  
Tel: 408-961-6444  
Fax: 408-961-6445

**Toronto**  
Mississauga, Ontario,  
Canada  
Tel: 905-673-0699  
Fax: 905-673-6509

### ASIA/PACIFIC

**Asia Pacific Office**  
Suites 3707-14, 37th Floor  
Tower 6, The Gateway  
Harbour City, Kowloon  
Hong Kong  
Tel: 852-2401-1200  
Fax: 852-2401-3431

**Australia - Sydney**  
Tel: 61-2-9868-6733  
Fax: 61-2-9868-6755

**China - Beijing**  
Tel: 86-10-8569-7000  
Fax: 86-10-8528-2104

**China - Chengdu**  
Tel: 86-28-8665-5511  
Fax: 86-28-8665-7889

**China - Chongqing**  
Tel: 86-23-8980-9588  
Fax: 86-23-8980-9500

**China - Hangzhou**  
Tel: 86-571-2819-3187  
Fax: 86-571-2819-3189

**China - Hong Kong SAR**  
Tel: 852-2943-5100  
Fax: 852-2401-3431

**China - Nanjing**  
Tel: 86-25-8473-2460  
Fax: 86-25-8473-2470

**China - Qingdao**  
Tel: 86-532-8502-7355  
Fax: 86-532-8502-7205

**China - Shanghai**  
Tel: 86-21-5407-5533  
Fax: 86-21-5407-5066

**China - Shenyang**  
Tel: 86-24-2334-2829  
Fax: 86-24-2334-2393

**China - Shenzhen**  
Tel: 86-755-8864-2200  
Fax: 86-755-8203-1760

**China - Wuhan**  
Tel: 86-27-5980-5300  
Fax: 86-27-5980-5118

**China - Xian**  
Tel: 86-29-8833-7252  
Fax: 86-29-8833-7256

**China - Xiamen**  
Tel: 86-592-2388138  
Fax: 86-592-2388130

**China - Zhuhai**  
Tel: 86-756-3210040  
Fax: 86-756-3210049

### ASIA/PACIFIC

**India - Bangalore**  
Tel: 91-80-3090-4444  
Fax: 91-80-3090-4123

**India - New Delhi**  
Tel: 91-11-4160-8631  
Fax: 91-11-4160-8632

**India - Pune**  
Tel: 91-20-2566-1512  
Fax: 91-20-2566-1513

**Japan - Osaka**  
Tel: 81-6-6152-7160  
Fax: 81-6-6152-9310

**Japan - Tokyo**  
Tel: 81-3-6880-3770  
Fax: 81-3-6880-3771

**Korea - Daegu**  
Tel: 82-53-744-4301  
Fax: 82-53-744-4302

**Korea - Seoul**  
Tel: 82-2-554-7200  
Fax: 82-2-558-5932 or  
82-2-558-5934

**Malaysia - Kuala Lumpur**  
Tel: 60-3-6201-9857  
Fax: 60-3-6201-9859

**Malaysia - Penang**  
Tel: 60-4-227-8870  
Fax: 60-4-227-4068

**Philippines - Manila**  
Tel: 63-2-634-9065  
Fax: 63-2-634-9069

**Singapore**  
Tel: 65-6334-8870  
Fax: 65-6334-8850

**Taiwan - Hsin Chu**  
Tel: 886-3-5778-366  
Fax: 886-3-5770-955

**Taiwan - Kaohsiung**  
Tel: 886-7-213-7828  
Fax: 886-7-330-9305

**Taiwan - Taipei**  
Tel: 886-2-2508-8600  
Fax: 886-2-2508-0102

**Thailand - Bangkok**  
Tel: 66-2-694-1351  
Fax: 66-2-694-1350

### EUROPE

**Austria - Wels**  
Tel: 43-7242-2244-39  
Fax: 43-7242-2244-393

**Denmark - Copenhagen**  
Tel: 45-4450-2828  
Fax: 45-4485-2829

**France - Paris**  
Tel: 33-1-69-53-63-20  
Fax: 33-1-69-30-90-79

**Germany - Munich**  
Tel: 49-89-627-144-0  
Fax: 49-89-627-144-44

**Italy - Milan**  
Tel: 39-0331-742611  
Fax: 39-0331-466781

**Netherlands - Drunen**  
Tel: 31-416-690399  
Fax: 31-416-690340

**Spain - Madrid**  
Tel: 34-91-708-08-90  
Fax: 34-91-708-08-91

**UK - Wokingham**  
Tel: 44-118-921-5869  
Fax: 44-118-921-5820

11/29/12

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Microchip:

[TC1411CPA](#) [TC1411COA](#) [TC1411NCOA713](#) [TC1411NEUA](#) [TC1411NEUA713](#) [TC1411NEOA](#) [TC1411NEPA](#)  
[TC1411EPA](#) [TC1411NEOA713](#) [TC1411EUA713](#) [TC1411NCPA](#) [TC1411NCOA](#) [TC1411COA713](#) [TC1411EOA](#)  
[TC1411EUA](#) [TC1411NVOA](#) [TC1411NVOA713](#) [TC1411NVPA](#) [TC1411NVUA](#) [TC1411NVUA713](#) [TC1411VOA](#)  
[TC1411VOA713](#) [TC1411VPA](#) [TC1411VUA](#) [TC1411VUA713](#) [TC1411EOA713](#)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А